

[Image sensor module]

# InGaAs area image sensor modules

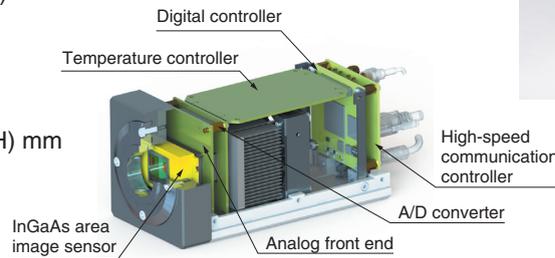
## C16090 series

NEW

The area image sensor modules consist of a driver circuit, temperature controller and high-speed communication controller, and they can drive InGaAs image sensors. Various settings can be configured by a PC via the USB 3.1 Gen 1 interface.

### FEATURES

- For near-infrared imaging (various options of wavelength ranges)
- Temperature controller included
- C-mount lens compatible
- Interface: USB 3.1 Gen 1
- Dimensions: 70 (W) × 145 (D) × 70 (H) mm
- Frame rate: 509 frames/s
- High dynamic range
- Supply voltage: 12 V



### Core technology

#### CORE DEVICE

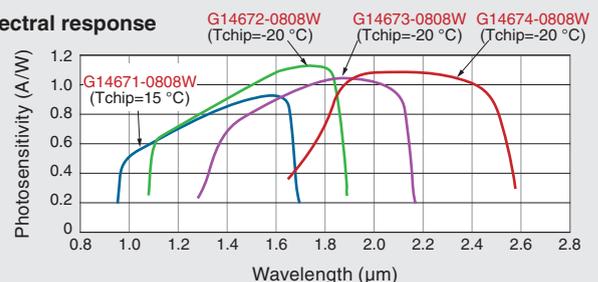
#### InGaAs area image sensors

An InGaAs area image sensor captures near-infrared 2D images. It consists of a high quantum efficiency, back-illuminated InGaAs photodiode array and a high gain and low noise ROIC (readout integrated circuit). The ROIC is equipped with a signal amplification circuit (analog) and a timing generator circuit (digital) on the same chip, enabling multi-functionality, high performance and low system cost. The temperature of the InGaAs photodiode can always be controlled by the built-in Peltier cooler and thermistor.

#### Lineup (320 × 256 ch, 20 μm pitch)

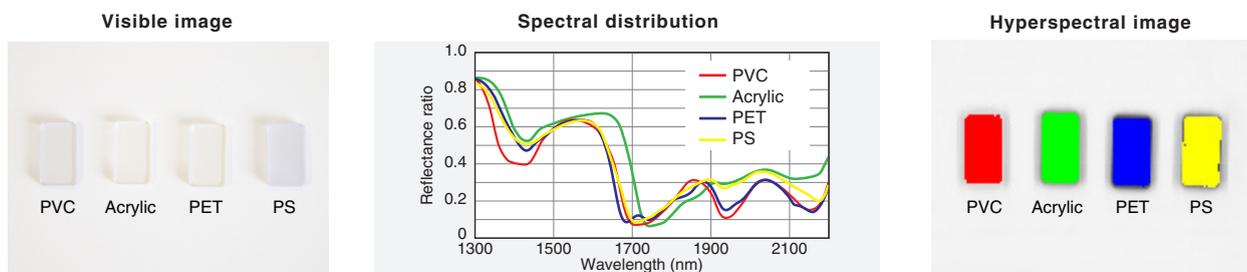
C16090	Built-in sensor	Spectral response range
-01	G14671-0808W	0.95 to 1.69 μm
-02	G14672-0808W	1.12 to 1.85 μm
-03	G14673-0808W	1.30 to 2.15 μm
-04	G14674-0808W	1.70 to 2.55 μm

#### Spectral response



### Application example

Hyperspectral cameras, which combine an InGaAs area image sensor and a special optical system, can acquire the image (positional information) and component determination (wavelength information) at the same time.



The module acquires images with wavelength information within the range of near-infrared region (1.3 μm to 2.2 μm)

Extract characteristics by spectral distribution analysis and identify materials via image processing